

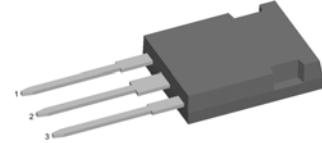
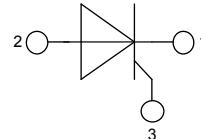
## Medium SCR

Single Thyristor

**V<sub>RRM</sub>** = 1200 V  
**I<sub>T(RMS)</sub>** = 126 A  
**I<sub>T(AV)M</sub>** = 80 A

Part number

CLA 80 E 1200 HF



Backside: anode

**Features / Advantages:**

- Thyristor for line frequency
- Planar passivated chip
- Long-term stability of blocking currents and voltages

**Applications:**

- Motor control
- Power converter
- AC power controller
- Switch mode and resonant mode power supplies
- Light and temperature control

**Package:**

- Housing: PLUS247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	Unit
$V_{RSM/DSM}$	max. non-repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ\text{C}$			1300	V
$V_{RRM/DRM}$	max. repetitive reverse/forward blocking voltage	$T_{VJ} = 25^\circ\text{C}$			1200	V
$I_{RD}$	reverse current, drain current	$V_R = 1200\text{ V}$ $V_R = 1200\text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		50 5	$\mu\text{A}$ mA
$V_T$	forward voltage	$I_F = 80\text{ A}$ $I_F = 160\text{ A}$ $I_F = 80\text{ A}$ $I_F = 160\text{ A}$	$T_{VJ} = 25^\circ\text{C}$  $T_{VJ} = 125^\circ\text{C}$		1.40 1.77 1.38 1.67	V
$I_{T(AV)M}$	max. average forward current	$T_C = 115^\circ\text{C}$	$T_{VJ} = 150^\circ\text{C}$		80	A
$I_{T(RMS)}$	RMS forward current	180° sine			126	A
$V_{TO}$ $r_T$	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 150^\circ\text{C}$		0.90 6	V $\text{m}\Omega$
$R_{thJC}$	thermal resistance junction to case				0.20	K/W
$T_{VJ}$	virtual junction temperature			-40	150	$^\circ\text{C}$
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		625	W
$P_{GM}$	max. gate power dissipation	$t_p = 30\ \mu\text{s}$ $t_p = 300\ \mu\text{s}$	$T_C = 150^\circ\text{C}$		10 5 0.5	W
$P_{GAV}$	average gate power dissipation					W
$I_{FSM}$	max. forward surge current	$t = 10\ \text{ms}; (50\ \text{Hz}), \text{sine}$ $t = 8,3\ \text{ms}; (60\ \text{Hz}), \text{sine}$ $t = 10\ \text{ms}; (50\ \text{Hz}), \text{sine}$ $t = 8,3\ \text{ms}; (60\ \text{Hz}), \text{sine}$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0\text{ V}$ $T_{VJ} = 150^\circ\text{C}$ $V_R = 0\text{ V}$		900 970 765 825	A
$I^{2t}$	value for fusing	$t = 10\ \text{ms}; (50\ \text{Hz}), \text{sine}$ $t = 8,3\ \text{ms}; (60\ \text{Hz}), \text{sine}$ $t = 10\ \text{ms}; (50\ \text{Hz}), \text{sine}$ $t = 8,3\ \text{ms}; (60\ \text{Hz}), \text{sine}$	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0\text{ V}$ $T_{VJ} = 150^\circ\text{C}$ $V_R = 0\text{ V}$		4.05 3.92 2.93 2.83	$\text{kA}^2\text{s}$ $\text{kA}^2\text{s}$ $\text{kA}^2\text{s}$ $\text{kA}^2\text{s}$
$C_J$	junction capacitance	$V_R = 400\text{ V}$ $f = 1\ \text{MHz}$	$T_{VJ} = 25^\circ\text{C}$	36		pF

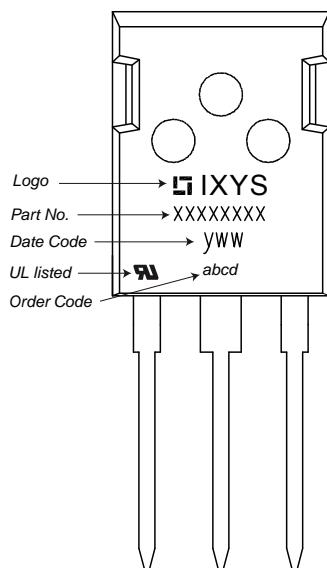
		Ratings			
Symbol	Definition	Conditions	min.	typ.	max.
$(di/dt)_{cr}$	critical rate of rise of current	$T_{VJ} = 150^\circ C$ repetitive, $I_T = 40 A$ $f = 50 \text{ Hz}; t_p = 200 \mu s$ $I_G = 0.3 A; di_G/dt = 0.3 A/\mu s$ $V_D = \frac{2}{3} V_{DRM}$ non-repetitive, $I_T = 50 A$			150 500 A/ $\mu s$
$(dv/dt)_{cr}$	critical rate of rise of voltage	$V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = 150^\circ C$ $R_{GK} = \infty$ ; method 1 (linear voltage rise)			1000 V/ $\mu s$
$V_{GT}$	gate trigger voltage	$V_D = 6 V$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$			1.5 1.6 V
$I_{GT}$	gate trigger current	$V_D = 6 V$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$			38 80 mA
$V_{GD}$	gate non-trigger voltage	$V_D = \frac{2}{3} V_{DRM}$ $T_{VJ} = 150^\circ C$			0.2 V
$I_{GD}$	gate non-trigger current				5 mA
$I_L$	latching current	$t_p = 10 \mu s$ $T_{VJ} = 25^\circ C$ $I_G = 0.3 A; di_G/dt = 0.3 A/\mu s$			150 mA
$I_H$	holding current	$V_D = 6 V$ $R_{GK} = \infty$ $T_{VJ} = 25^\circ C$			100 mA
$t_{gd}$	gate controlled delay time	$V_R = \frac{1}{2} V_{DRM}$ $T_{VJ} = 25^\circ C$ $I_G = 0.3 A; di_G/dt = 0.3 A/\mu s$			2 $\mu s$
$t_q$	turn-off time	$V_R = 100 V; I_T = 48 A$ $T_{VJ} = 25^\circ C$ $V_D = \frac{2}{3} V_{DRM}; t_p = 200 \mu s$ $di/dt = 20 A/\mu s; dv/dt = 20 V/\mu s$		150	$\mu s$

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			70	A
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$F_c$	mounting force with clip		20		120	N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.  
In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

#### Part number

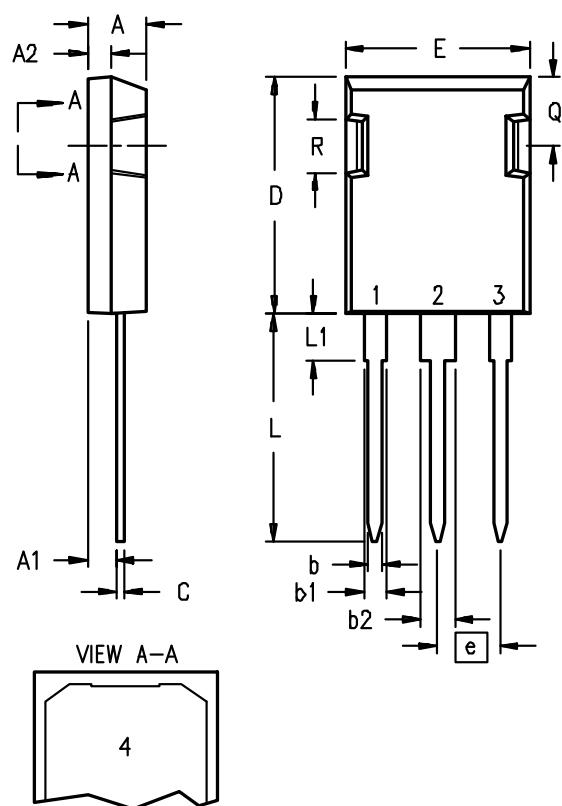
#### Product Marking



C = Thyristor (SCR)  
L = Medium SCR  
A = (up to 1200V)  
80 = Current Rating [A]  
E = Single Thyristor  
1200 = Reverse Voltage [V]  
HF = PLUS247 (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	CLA 80 E 1200 HF	CLA80E1200HF	Tube	30	508680

## Outlines PLUS247



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.83	5.21	0.19	0.205
A1	2.29	2.54	0.09	0.1
A2	1.91	2.16	0.075	0.085
b	1.14	1.4	0.045	0.055
b1	1.91	2.13	0.075	0.084
b2	2.92	3.12	0.115	0.123
C	0.61	0.8	0.024	0.031
D	20.8	21.34	0.819	0.84
E	15.75	16.13	0.62	0.635
e	5.45 BSC		.215 BSC	
L	19.81	20.32	0.78	0.8
L1	3.81	4.32	0.15	0.17
Q	5.59	6.2	0.22	0.244
R	4.32	4.83	0.17	0.19